# **Question Paper Code: 41274**

### M.E. DEGREE EXAMINATION, DECEMBER 2014.

First Semester

### VLSI Design

### 14PVL104 – SOLID STATE DEVICES MODELING AND SIMULATION

	(Regulation 2014)					
	Duration: Three ho		ALL Questions.	Maximum: 100 Marks		
		PART A - (	$(5 \times 1 = 5 \text{ Marks})$			
1.	. In a Silicon MOSrET, the gate contact is separated from by an insulation dioxide layer (SiO <sub>2</sub> ).					
	(a) the channel	(b) the gate	(c) the drain	(d) the source		
2.	Which is the high f	requency noise				
	(a) White Noise	(b) Thermal Noise	(c) Flicker Noise	(d) Induced Gate noise		
3.	BSIM stands for					
	(a) Boltzmann Short-Channel IGFET Model					
	(b) Berkeley Short-Channel IGFET Model					
	(c) Boltzmann Small -Channel IGFET Model					
	(d) Berkeley Small -Channel IGFET Model					
4.	The EKV model has assigned the node as reference node.					
	(a) source	(b) drain	(c) bulk	(d) gate		
5.	In poly resistors, the equivalent circuit is valid at frequency up to					
	(a) 1 GHz	(b) 20 GHz	(c) 2 GHz	(d) 10 GHz		

## PART - B (5 x 3 = 15 Marks)

6.	Draw the equivalent circuit of MOS Transistor.				
7.	List out the noise sources in MOSFETs.				
8.	Write short notes on layout dependent parasitic model.				
9.	List the effects of drain current in EKV model.				
10.	What is process variation? How it affects the performance of a MOSFET devices?				
	PART - C (5 x $16 = 80 \text{ Marks}$ )				
11.	(a) Give a detailed account of high frequency behavior of MOS transistor and ac s signal modeling.	mall (16)			
	Or				
	(b) Explain the three basic three models of MOSFETs and also derive the expressi the threshold voltage of MOSFET.	on for (16)			
12.	(a) With neat Sketch, Explain the modelling of Nonlinearity in CMOS Devices.  Or	(16)			
	(b) Explain flicker and noise modelling.	(16)			
13.	(a) (i) What is mobility model? Explain its working.	(8)			
	(ii) Discuss the modelling of Junction diode model using BSIM 4 MOSFET.  Or	(8)			
	(b) Explain BSIM 4 substrate model and channel charge model with suitable equations.				
		(16)			
14.	(a) Explain the modelling of charge storage effects and non-quasi –static models.	(16)			
	Or				
	(b) With neat sketch, explain the operation of EKV model.	(16)			
15.	(a) Describe the modelling of device mismatch for analog RF applications.	(16)			
	Or				
	(b) Explain Benchmark circuits for quality assurance.	(16)			